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Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

#### Details

Product Status	Obsolete
Core Processor	80C51
Core Size	8-Bit
Speed	40/20MHz
Connectivity	UART/USART
Peripherals	POR
Number of I/O	32
Program Memory Size	8KB (8K x 8)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	256 x 8
Voltage - Supply (Vcc/Vdd)	4.5V ~ 5.5V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Surface Mount
Package / Case	44-QFP
Supplier Device Package	44-VQFP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/ts87c52x2-mce

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

# **Pin Configuration**



\*NIC: No Internal Connection

![](_page_1_Picture_4.jpeg)

![](_page_2_Picture_0.jpeg)

Mnemonic		Pin Nu	mber	Туре	Name and Function		
	DIL	LCC	VQFP 1.4				
V <sub>SS</sub>	20	22	16	I	Ground: 0V reference		
Vss1		1	39	I	Optional Ground: Contact the Sales Office for ground connection.		
V <sub>cc</sub>	40	44	38	I	<b>Power Supply:</b> This is the power supply voltage for normal, idle and power-down operation		
P0.0-P0.7	39- 32	43- 36	37-30	I/O	<b>Port 0</b> : Port 0 is an open-drain, bidirectional I/O port. Port 0 pins that have 1s written to them float and can be used as bidh impedance inputs Port 0 pins must be polarized to Vcc.		
					or Vss in order to prevent any parasitic current consumption. Port 0 is also the multiplexed low-order address and data bus during access to external program and data memory. In this application, it uses strong internal pull-up when emitting 1s. Port 0 also inputs the code bytes during EPROM programming. External pull-ups are required during program verification during which P0 outputs the code bytes.		
P1.0-P1.7	1-8	2-9	40-44 1-3	I/O	Port 1: Port 1 is an 8-bit bidirectional I/O port with internal pull-ups. Port 1 pins that have 1s written to them are pulled bids by the internal pull-ups and can be used as inputs. As		
					high by the internal pull-ups and can be used as inputs. As inputs, Port 1 pins that are externally pulled low will source current because of the internal pull-ups. Port 1 also receive the low-order address byte during memory programming a verification.		
	1	2	40	I/O	T2 (P1.0): Timer/Counter 2 external count input/Clockout		
	2	3	41	1	<b>T2EX (P1.1):</b> Timer/Counter 2 Reload/Capture/Direction Control		
P2.0-P2.7	21- 28	24- 31	18-25	I/O	<b>Port 2</b> : Port 2 is an 8-bit bidirectional I/O port with internal pull-ups. Port 2 pins that have 1s written to them are pulled with a structure of a structure of the structure		
					high by the internal pull-ups and can be used as inputs. As inputs, Port 2 pins that are externally pulled low will source current because of the internal pull-ups. Port 2 emits the high- order address byte during fetches from external program memory and during accesses to external data memory that use 16-bit addresses (MOVX atDPTR). In this application, it uses strong internal pull-ups emitting 1s. During accesses to external data memory that use 8-bit addresses (MOVX atRi), port 2 emits the contents of the P2 SFR. Some Port 2 pins receive the high order address bits during EPROM programming and verification: P2.0 to P2.4		
P3.0-P3.7	10- 17	11, 13- 19	5, 7-13	I/O	Port 3: Port 3 is an 8-bit bidirectional I/O port with internal pull-ups. Port 3 pins that have 1s written to them are pulle high by the internal pull-ups and can be used as inputs. As inputs, Port 3 pins that are externally pulled low will source		
					current because of the internal pull-ups. Port 3 also serves the special features of the 80C51 family, as listed below.		
	10	11	5	I	RXD (P3.0): Serial input port		
	11	13	7	0	TXD (P3.1): Serial output port		
	12	14	8	Ι	INT0 (P3.2): External interrupt 0		

TS8xCx2X2

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![](_page_3_Figure_1.jpeg)

Figure 2. Mode Switching Waveforms

The X2 bit in the CKCON register (See Table 3.) allows to switch from 12 clock cycles per instruction to 6 clock cycles and vice versa. At reset, the standard speed is activated (STD mode). Setting this bit activates the X2 feature (X2 mode).

Note: In order to prevent any incorrect operation while operating in X2 mode, user must be aware that all peripherals using clock frequency as time reference (UART, timers) will have their time reference divided by two. For example a free running timer generating an interrupt every 20 ms will then generate an interrupt every 10 ms. UART with 4800 baud rate will have 9600 baud rate.

# Table 3. CKCON Register

CKCON - Clock Control Register (8Fh)

7	6	5	4	3	2	1	0			
-	-	-	-	-	-	-	X2			
Bit Number	Bit Mnemonic	Description	Description							
7	-	<b>Reserved</b> The value rea	<b>teserved</b> The value read from this bit is indeterminate. Do not set this bit.							
6	-	Reserved The value rea	Reserved The value read from this bit is indeterminate. Do not set this bit.							
5	-	Reserved The value rea	Reserved The value read from this bit is indeterminate. Do not set this bit.							
4	-	Reserved The value read from this bit is indeterminate. Do not set this bit.								
3	-	<b>Reserved</b> The value read from this bit is indeterminate. Do not set this bit.								
2	-	<b>Reserved</b> The value read from this bit is indeterminate. Do not set this bit.								
1	-	<b>Reserved</b> The value read from this bit is indeterminate. Do not set this bit.								
0	X2	<b>CPU and peripheral clock bit</b> Clear to select 12 clock periods per machine cycle (STD mode, $F_{OSC}=F_{XTAL}/2$ ). Set to select 6 clock periods per machine cycle (X2 mode, $F_{OSC}=F_{XTAL}$ ).								

Reset Value = XXXX XXX0b

Not bit addressable

For further details on the X2 feature, please refer to ANM072 available on the web (http://www.atmel.com)

![](_page_3_Picture_11.jpeg)

# Application

Software can take advantage of the additional data pointers to both increase speed and reduce code size, for example, block operations (copy, compare, search ...) are well served by using one data pointer as a 'source' pointer and the other one as a "destination" pointer.

ASSEMBLY LANGUAGE

; Block move using dual data pointers ; Destroys DPTR0, DPTR1, A and PSW ; note: DPS exits opposite of entry state ; unless an extra INC AUXR1 is added 00A2 AUXR1 EQU 0A2H 0000 909000MOV DPTR,#SOURCE ; address of SOURCE 0003 05A2 INC AUXR1 ; switch data pointers 0005 90A000 MOV DPTR,#DEST ; address of DEST 0008 LOOP: 0008 05A2 INC AUXR1 ; switch data pointers 000A E0 MOVX A, atDPTR ; get a byte from SOURCE 000B A3 INC DPTR ; increment SOURCE address 000C 05A2 INC AUXR1 ; switch data pointers 000E F0 MOVX atDPTR, A ; write the byte to DEST 000F A3 INC DPTR ; increment DEST address 0010 70F6JNZ LOOP ; check for 0 terminator 0012 05A2 INC AUXR1 ; (optional) restore DPS

INC is a short (2 bytes) and fast (12 clocks) way to manipulate the DPS bit in the AUXR1 SFR. However, note that the INC instruction does not directly force the DPS bit to a particular state, but simply toggles it. In simple routines, such as the block move example, only the fact that DPS is toggled in the proper sequence matters, not its actual value. In other words, the block move routine works the same whether DPS is '0' or '1' on entry. Observe that without the last instruction (INC AUXR1), the routine will exit with DPS in the opposite state.

![](_page_4_Picture_6.jpeg)

Timer 2	The timer 2 in the TS80C52X2 is compatible with the timer 2 in the 80C52. It is a 16-bit timer/counter: the count is maintained by two eight-bit timer registers, TH2 and TL2, connected in cascade. It is controlled by T2CON register (See Table 5) and T2MOD register (See Table 6). Timer 2 operation is similar to Timer 0 and Timer 1. C/T2 selects $F_{OSC}/12$ (timer operation) or external pin T2 (counter operation) as the timer clock input. Setting TR2 allows TL2 to be incremented by the selected input.				
	Timer 2 has 3 operating modes: capture, autoreload and Baud Rate Generator. These modes are selected by the combination of RCLK, TCLK and CP/RL2 (T2CON), as described in the Atmel 8-bit Microcontroller Hardware description.				
	Refer to the Atmel 8-bit Microcontroller Hardware description for the description of Cap- ture and Baud Rate Generator Modes.				
	In TS80C52X2 Timer 2 includes the following enhancements:				
	Auto-reload mode with up or down counter				
	Programmable clock-output				
Auto-reload Mode	The Auto-reload mode configures timer 2 as a 16-bit timer or event counter with auto- matic reload. If DCEN bit in T2MOD is cleared, timer 2 behaves as in 80C52 (refer to the Atmel 8-bit Microcontroller Hardware description). If DCEN bit is set, timer 2 acts as an Up/down timer/counter as shown in Figure 4. In this mode the T2EX pin controls the direction of count.				
	When T2EX is high, timer 2 counts up. Timer overflow occurs at FFFFh which sets the TF2 flag and generates an interrupt request. The overflow also causes the 16-bit value in RCAP2H and RCAP2L registers to be loaded into the timer registers TH2 and TL2.				
	When T2EX is low, timer 2 counts down. Timer underflow occurs when the count in the timer registers TH2 and TL2 equals the value stored in RCAP2H and RCAP2L registers. The underflow sets TF2 flag and reloads FFFFh into the timer registers.				
	The EXF2 bit toggles when timer 2 overflows or underflows according to the the direc- tion of the count. EXF2 does not generate any interrupt. This bit can be used to provide				

17-bit resolution.

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# Table 14.IPH RegisterIPH - Interrupt Priority High Register (B7h)

7	6	5	4	3	2	1	0		
-	-	PT2H	PSH	PT1H	PX1H	РТОН	РХОН		
Bit Number	Bit Mnemonic	Description	Description						
7	-	<b>Reserved</b> The value rea	e value read from this bit is indeterminate. Do not set this bit.						
6	-	Reserved The value rea	eserved he value read from this bit is indeterminate. Do not set this bit.						
5	PT2H	Timer 2 over           PT2H         PT2           0         0           1         0           1         1	flow interrup Priority Leve Lowest Highest	t Priority Higl <sub>임</sub>	ı bit				
4	PSH	Serial port P           PSH         PS           0         0           1         0           1         1	<b>riority High b</b> <u>Priority Leve</u> Lowest Highest	it el					
3	PT1H	Timer 1 over           PT1H         PT1           0         0           1         0           1         1	flow interrupt Priority Leve Lowest Highest	t Priority Higl ગ	ו bit				
2	PX1H	External inte           PX1H         PX1           0         0           0         1           1         0           1         1	<b>rrupt 1 Priori</b> <u>Priority Leve</u> Lowest Highest	ty High bit 한					
1	РТОН	Timer 0 over           PTOH         PTO           0         0           1         0           1         1	flow interrup Priority Leve Lowest Highest	t Priority Higl <u>위</u>	ı bit				
0	РХОН	External inte           PXOH         PXO           0         0           0         1           1         0           1         1	rrupt 0 Priori Priority Leve Lowest Highest	ty High bit 1					

Reset Value = XX00 0000b Not bit addressable

![](_page_6_Picture_5.jpeg)

Exit from power-down by reset redefines all the SFRs, exit from power-down by external interrupt does no affect the SFRs.

Exit from power-down by either reset or external interrupt does not affect the internal RAM content.

Note: If idle mode is activated with power-down mode (IDL and PD bits set), the exit sequence is unchanged, when execution is vectored to interrupt, PD and IDL bits are cleared and idle mode is not entered.

Mode	Program Memory	ALE	PSEN	PORT0	PORT1	PORT2	PORT3
Idle	Internal	1	1	Port Data <sup>(1)</sup>	Port Data	Port Data	Port Data
Idle	External	1	1	Floating	Port Data Address		Port Data
Power Down	Internal	0	0	Port Data <sup>(1)</sup>	Port Data	Port Data	Port Data
Power Down	External	0	0	Floating	Port Data	Port Data	Port Data

**Table 15.** The State of Ports During Idle and Power-down Modes

Note: 1. Port 0 can force a "zero" level. A "one" will leave port floating.

![](_page_7_Picture_7.jpeg)

![](_page_8_Picture_0.jpeg)

# ONCE<sup>™</sup> Mode (ON Chip Emulation)

The ONCE mode facilitates testing and debugging of systems using TS80C52X2 without removing the circuit from the board. The ONCE mode is invoked by driving certain pins of the TS80C52X2; the following sequence must be exercised:

- Pull ALE low while the device is in reset (RST high) and PSEN is high.
- Hold ALE low as RST is deactivated.

While the TS80C52X2 is in ONCE mode, an emulator or test CPU can be used to drive the circuit Table 26. shows the status of the port pins during ONCE mode.

Normal operation is restored when normal reset is applied.

Table 16. External Pin Status during ONCE Mode

ALE	PSEN	Port 0	Port 1	Port 2	Port 3	XTAL1/2
Weak pull- up	Weak pull- up	Float	Weak pull- up	Weak pull- up	Weak pull- up	Active

![](_page_9_Picture_0.jpeg)

# **Reduced EMI Mode**

The ALE signal is used to demultiplex address and data buses on port 0 when used with external program or data memory. Nevertheless, during internal code execution, ALE signal is still generated. In order to reduce EMI, ALE signal can be disabled by setting AO bit.

The AO bit is located in AUXR register at bit location 0. As soon as AO is set, ALE is no longer output but remains active during MOVX and MOVC instructions and external fetches. During ALE disabling, ALE pin is weakly pulled high.

# Table 18. AUXR Register

AUXR - Auxiliary Register (8Eh)

7	6	5	4	3	2	1	0			
-	-	-	-	-	-	-	AO			
Bit Number	Bit Mnemonic	Description	Description							
7	-	Reserved The value rea	Reserved The value read from this bit is indeterminate. Do not set this bit.							
6	-	Reserved The value rea	Reserved The value read from this bit is indeterminate. Do not set this bit.							
5	-	Reserved The value rea	Reserved The value read from this bit is indeterminate. Do not set this bit.							
4	-	Reserved The value rea	Reserved The value read from this bit is indeterminate. Do not set this bit.							
3	-	<b>Reserved</b> The value read from this bit is indeterminate. Do not set this bit.								
2	-	<b>Reserved</b> The value read from this bit is indeterminate. Do not set this bit.								
1	-	<b>Reserved</b> The value read from this bit is indeterminate. Do not set this bit.								
0	AO	ALE Output bit Clear to restore ALE operation during internal fetches. Set to disable ALE operation during internal fetches.								

Reset Value = XXXX XXX0b Not bit addressable

# TS8xCx2X2

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Symbol	Parameter	Min	Тур	Max	Unit	Test Conditions
V <sub>OH</sub>	Output High Voltage, ports 1, 2, 3	V <sub>CC</sub> - 0.3 V <sub>CC</sub> - 0.7 V <sub>CC</sub> - 1.5			V V V	$I_{OH} = -10 \ \mu A$ $I_{OH} = -30 \ \mu A$ $I_{OH} = -60 \ \mu A$ $V_{CC} = 5V \pm 10\%$
V <sub>OH1</sub>	Output High Voltage, port 0	V <sub>CC</sub> - 0.3 V <sub>CC</sub> - 0.7 V <sub>CC</sub> - 1.5			> > >	$I_{OH} = -200 \ \mu A$ $I_{OH} = -3.2 \ m A$ $I_{OH} = -7.0 \ m A$ $V_{CC} = 5V \pm 10\%$
V <sub>OH2</sub>	Output High Voltage,ALE, PSEN	V <sub>CC</sub> - 0.3 V <sub>CC</sub> - 0.7 V <sub>CC</sub> - 1.5			V V V	$I_{OH} = -100 \ \mu A$ $I_{OH} = -1.6 \ m A$ $I_{OH} = -3.5 \ m A$ $V_{CC} = 5V \pm 10\%$
R <sub>RST</sub>	RST Pulldown Resistor	50	90 <sup>(5)</sup>	200	kΩ	
I <sub>IL</sub>	Logical 0 Input Current ports 1, 2 and 3			-50	μΑ	Vin = 0.45V
I <sub>LI</sub>	Input Leakage Current			±10	μΑ	0.45V < Vin < V <sub>CC</sub>
I <sub>TL</sub>	Logical 1 to 0 Transition Current, ports 1, 2, 3			-650	μA	Vin = 2.0 V
C <sub>IO</sub>	Capacitance of I/O Buffer			10	pF	Fc = 1 MHz TA = 25°C
I <sub>PD</sub>	Power Down Current		20 (5)	50	μA	$2.0 \text{ V} < \text{V}_{\text{CC}} < 5.5 \text{V}^{(3)}$
I <sub>CC</sub> under RESET	Power Supply Current Maximum values, X1 mode: (7)			1 + 0.4 Freq (MHz) at12MHz 5.8 at16MHz 7.4	mA	$V_{\rm CC} = 5.5 V^{(1)}$
I <sub>CC</sub> operating	Power Supply Current Maximum values, X1 mode: (7)			3 + 0.6 Freq (MHz) at12MHz 10.2 at16MHz 12.6	mA	$V_{\rm CC} = 5.5 V^{(8)}$
I <sub>CC</sub> idle	Power Supply Current Maximum values, X1 mode: (7)			0.25+0.3 Freq (MHz) at12MHz 3.9 at16MHz 5.1	mA	$V_{\rm CC} = 5.5 V^{(2)}$

![](_page_10_Picture_3.jpeg)

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Port 0: 26 mA Ports 1, 2 and 3: 15 mA Maximum total  $I_{OL}$  for all output pins: 71 mA If  $I_{OL}$  exceeds the test condition,  $V_{OL}$  may exceed the related specification. Pins are not guaranteed to sink current greater than the listed test conditions.

- 7. For other values, please contact your sales office.
- Operating I<sub>CC</sub> is measured with all output pins disconnected; XTAL1 driven with T<sub>CLCH</sub>, T<sub>CHCL</sub> = 5 ns (see Figure 17.), V<sub>IL</sub> = V<sub>SS</sub> + 0.5V,

 $V_{IH} = V_{CC} - 0.5V$ ; XTAL2 N.C.;  $\overline{EA} = Port 0 = V_{CC}$ ; RST =  $V_{SS}$ . The internal ROM runs the code 80 FE (label: SJMP label). I<sub>CC</sub> would be slightly higher if a crystal oscillator is used. Measurements are made with OTP products when possible, which is the worst case.

Figure 13.  $I_{CC}$  Test Condition, under reset

![](_page_11_Figure_6.jpeg)

All other pins are disconnected.

![](_page_11_Figure_8.jpeg)

![](_page_11_Figure_9.jpeg)

All other pins are disconnected.

Figure 15. I<sub>CC</sub> Test Condition, Idle Mode

![](_page_11_Figure_12.jpeg)

All other pins are disconnected.

![](_page_11_Picture_14.jpeg)

# External Program Memory Read Cycle

Figure 18. External Program Memory Read Cycle

![](_page_12_Figure_3.jpeg)

# External Data Memory Characteristics

 Table 29.
 Symbol Description

Symbol	Parameter
T <sub>RLRH</sub>	RD Pulse Width
T <sub>WLWH</sub>	WR Pulse Width
T <sub>RLDV</sub>	RD to Valid Data In
T <sub>RHDX</sub>	Data Hold After RD
T <sub>RHDZ</sub>	Data Float After RD
T <sub>LLDV</sub>	ALE to Valid Data In
T <sub>AVDV</sub>	Address to Valid Data In
T <sub>LLWL</sub>	ALE to WR or RD
T <sub>AVWL</sub>	Address to WR or RD
T <sub>QVWX</sub>	Data Valid to WR Transition
T <sub>QVWH</sub>	Data set-up to WR High
T <sub>WHQX</sub>	Data Hold After WR
T <sub>RLAZ</sub>	RD Low to Address Float
T <sub>WHLH</sub>	RD or WR High to ALE high

![](_page_12_Picture_7.jpeg)

![](_page_13_Picture_0.jpeg)

Table 30.	AC Parameters	for a	Fix	Clock
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Speed	-1 40 M	M MHz	 X2 n 30 M 60 M equ	V node MHz MHz uiv.	'- stan mod Mi	V dard le 40 Hz	- X2 n 20 f 40 f equ	L node MHz MHz uiv.	- stan mo 30 N	L dard ode MHz	Units
Symbol	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	
T <sub>RLRH</sub>	130		85		135		125		175		ns
T <sub>WLWH</sub>	130		85		135		125		175		ns
T <sub>RLDV</sub>		100		60		102		95		137	ns
T <sub>RHDX</sub>	0		0		0		0		0		ns
T <sub>RHDZ</sub>		30		18		35		25		42	ns
T <sub>LLDV</sub>		160		98		165		155		222	ns
T <sub>AVDV</sub>		165		100		175		160		235	ns
T <sub>LLWL</sub>	50	100	30	70	55	95	45	105	70	130	ns
T <sub>AVWL</sub>	75		47		80		70		103		ns
T <sub>QVWX</sub>	10		7		15		5		13		ns
T <sub>QVWH</sub>	160		107		165		155		213		ns
T <sub>WHQX</sub>	15		9		17		10		18		ns
T <sub>RLAZ</sub>		0		0		0		0		0	ns
T <sub>WHLH</sub>	10	40	7	27	15	35	5	45	13	53	ns

Symbol	Туре	Standard Clock	X2 Clock	-М	-V	-L	Units
T <sub>RLRH</sub>	Min	6 T - x	3 T - x	20	15	25	ns
T <sub>WLWH</sub>	Min	6 T - x	3 T - x	20	15	25	ns
T <sub>RLDV</sub>	Max	5 T - x	2.5 T - x	25	23	30	ns
T <sub>RHDX</sub>	Min	х	х	0	0	0	ns
T <sub>RHDZ</sub>	Max	2 T - x	T - x	20	15	25	ns
T <sub>LLDV</sub>	Max	8 T - x	4T -x	40	35	45	ns
T <sub>AVDV</sub>	Max	9 T - x	4.5 T - x	60	50	65	ns
T <sub>LLWL</sub>	Min	3 T - x	1.5 T - x	25	20	30	ns
T <sub>LLWL</sub>	Max	3 T + x	1.5 T + x	25	20	30	ns
T <sub>AVWL</sub>	Min	4 T - x	2 T - x	25	20	30	ns
T <sub>QVWX</sub>	Min	T - x	0.5 T - x	15	10	20	ns
T <sub>QVWH</sub>	Min	7 T - x	3.5 T - x	15	10	20	ns
T <sub>WHQX</sub>	Min	T - x	0.5 T - x	10	8	15	ns
T <sub>RLAZ</sub>	Max	х	х	0	0	0	ns
T <sub>WHLH</sub>	Min	T - x	0.5 T - x	15	10	20	ns
T <sub>WHLH</sub>	Max	T + x	0.5 T + x	15	10	20	ns

Table 31. AC Parameters for a Variable Clock: Derating Formula

# External Data Memory Write Cycle

![](_page_14_Figure_4.jpeg)

![](_page_14_Figure_5.jpeg)

![](_page_15_Picture_0.jpeg)

# **EPROM Programming and** Verification Characteristics

 $T_A$  = 21°C to 27°C;  $V_{SS}$  = 0V;  $~V_{CC}$  = 5V  $\pm$  10% while programming.  $V_{CC}$  = operating range while verifying.

 Table 35.
 EPROM Programming Parameters

Symbol	Parameter	Min	Max	Units
V <sub>PP</sub>	Programming Supply Voltage	12.5	13	V
I <sub>PP</sub>	Programming Supply Current		75	mA
1/T <sub>CLCL</sub>	Oscillator Frquency	4	6	MHz
T <sub>AVGL</sub>	Address Setup to PROG Low	48 T <sub>CLCL</sub>		
T <sub>GHAX</sub>	Adress Hold after PROG	48 T <sub>CLCL</sub>		
T <sub>DVGL</sub>	Data Setup to PROG Low	48 T <sub>CLCL</sub>		
T <sub>GHDX</sub>	Data Hold after PROG	48 T <sub>CLCL</sub>		
T <sub>EHSH</sub>	(Enable) High to V <sub>PP</sub>	48 T <sub>CLCL</sub>		
T <sub>SHGL</sub>	V <sub>PP</sub> Setup to PROG Low	10		μs
T <sub>GHSL</sub>	V <sub>PP</sub> Hold after PROG	10		μs
T <sub>GLGH</sub>	PROG Width	90	110	μs
T <sub>AVQV</sub>	Address to Valid Data		48 T <sub>CLCL</sub>	
T <sub>ELQV</sub>	ENABLE Low to Data Valid		48 T <sub>CLCL</sub>	
T <sub>EHQZ</sub>	Data Float after ENABLE	0	48 T <sub>CLCL</sub>	

# EPROM Programming and Verification Waveforms

# Figure 22. EPROM Programming and Verification Waveforms

![](_page_15_Figure_7.jpeg)

\* 8KB: up to P2.4, 16KB: up to P2.5, 32KB: up to P3.4, 64KB: up to P3.5

![](_page_16_Picture_0.jpeg)

![](_page_16_Figure_1.jpeg)

Figure 26. Clock Waveforms

![](_page_16_Figure_3.jpeg)

This diagram indicates when signals are clocked internally. The time it takes the signals to propagate to the pins, however, ranges from 25 to 125 ns. This propagation delay is dependent on variables such as temperature and pin loading. Propagation also varies from output to output and component. Typically though ( $T_A = 25^{\circ}C$  fully loaded) RD and WR propagation delays are approximately 50ns. The other signals are typically 85 ns. Propagation delays are incorporated in the AC specifications.

# **Ordering Information**

# Table 37. Possible Ordering Entries

Part Number <sup>(3)</sup>	Memory Size	Supply Voltage	Temperature Range	Max Frequency	Package	Packing
TS80C32X2-MCA	ROMLess	5V <u>±</u> 10%	Commercial	40 MHz <sup>(1)</sup>	PDIL40	Stick
TS80C32X2-MCB	ROMLess	5V <u>±</u> 10%	Commercial	40 MHz <sup>(1)</sup>	PLCC44	Stick
TS80C32X2-MCC	ROMLess	5V <u>±</u> 10%	Commercial	40 MHz <sup>(1)</sup>	PQFP44	Tray
TS80C32X2-MCE	ROMLess	5V <u>±</u> 10%	Commercial	40 MHz <sup>(1)</sup>	VQFP44	Tray
TS80C32X2-LCA	ROMLess	2.7 to 5.5V	Commercial	30 MHz <sup>(1)</sup>	PDIL40	Stick
TS80C32X2-LCB	ROMLess	2.7 to 5.5V	Commercial	30 MHz <sup>(1)</sup>	PLCC44	Stick
TS80C32X2-LCC	ROMLess	2.7 to 5.5V	Commercial	30 MHz <sup>(1)</sup>	PQFP44	Tray
TS80C32X2-LCE	ROMLess	2.7 to 5.5V	Commercial	30 MHz <sup>(1)</sup>	VQFP44	Tray
TS80C32X2-VCA	ROMLess	5V <u>±</u> 10%	Commercial	60 MHz <sup>(3)</sup>	PDIL40	Stick
TS80C32X2-VCB	ROMLess	5V <u>±</u> 10%	Commercial	60 MHz <sup>(3)</sup>	PLCC44	Stick
TS80C32X2-VCC	ROMLess	5V <u>±</u> 10%	Commercial	60 MHz <sup>(3)</sup>	PQFP44	Tray
TS80C32X2-VCE	ROMLess	5V <u>±</u> 10%	Commercial	60 MHz <sup>(3)</sup>	VQFP44	Tray
TS80C32X2-MIA	ROMLess	5V <u>±</u> 10%	Industrial	40 MHz <sup>(1)</sup>	PDIL40	Stick
TS80C32X2-MIB	ROMLess	5V <u>±</u> 10%	Industrial	40 MHz <sup>(1)</sup>	PLCC44	Stick
TS80C32X2-MIC	ROMLess	5V <u>±</u> 10%	Industrial	40 MHz <sup>(1)</sup>	PQFP44	Tray
TS80C32X2-MIE	ROMLess	5V <u>±</u> 10%	Industrial	40 MHz <sup>(1)</sup>	VQFP44	Tray
TS80C32X2-LIA	ROMLess	2.7 to 5.5V	Industrial	30 MHz <sup>(1)</sup>	PDIL40	Stick
TS80C32X2-LIB	ROMLess	2.7 to 5.5V	Industrial	30 MHz <sup>(1)</sup>	PLCC44	Stick
TS80C32X2-LIC	ROMLess	2.7 to 5.5V	Industrial	30 MHz <sup>(1)</sup>	PQFP44	Tray
TS80C32X2-LIE	ROMLess	2.7 to 5.5V	Industrial	30 MHz <sup>(1)</sup>	VQFP44	Tray
TS80C32X2-VIA	ROMLess	5V <u>±</u> 10%	Industrial	60 MHz <sup>(3)</sup>	PDIL40	Stick
TS80C32X2-VIB	ROMLess	5V <u>±</u> 10%	Industrial	60 MHz <sup>(3)</sup>	PLCC44	Stick
TS80C32X2-VIC	ROMLess	5V <u>±</u> 10%	Industrial	60 MHz <sup>(3)</sup>	PQFP44	Tray
TS80C32X2-VIE	ROMLess	5V <u>±</u> 10%	Industrial	60 MHz <sup>(3)</sup>	VQFP44	Tray
AT80C32X2-3CSUM	ROMLess	5V ±10%	Industrial & Green	40 MHz <sup>(1)</sup>	PDIL40	Stick
AT80C32X2-SLSUM	ROMLess	5V ±10%	Industrial & Green	40 MHz <sup>(1)</sup>	PLCC44	Stick
AT80C32X2-RLTUM	ROMLess	5V ±10%	Industrial & Green	40 MHz <sup>(1)</sup>	VQFP44	Tray
AT80C32X2-RLTUM	ROMLess	5V ±10%	Industrial & Green	40 MHz <sup>(1)</sup>	VQFP44	Tape & Reel
AT80C32X2-3CSUL	ROMLess	2.7 to 5.5V	Industrial & Green	30 MHz <sup>(1)</sup>	PDIL40	Stick
AT80C32X2-SLSUL	ROMLess	2.7 to 5.5V	Industrial & Green	30 MHz <sup>(1)</sup>	PLCC44	Stick

![](_page_17_Picture_4.jpeg)

![](_page_18_Picture_0.jpeg)

# Table 37. Possible Ordering Entries (Continued)

			Tomporatura			
Part Number <sup>(3)</sup>	Memory Size	Supply Voltage	Range	Max Frequency	Package	Packing
AT80C32X2-RLTUL	ROMLess	2.7 to 5.5V	Industrial & Green	30 MHz <sup>(1)</sup>	VQFP44	Tray
AT80C32X2-3CSUV	ROMLess	5V ±10%	Industrial & Green	60 MHz <sup>(3)</sup>	PDIL40	Stick
AT80C32X2-SLSUV	ROMLess	5V ±10%	Industrial & Green	60 MHz <sup>(3)</sup>	PLCC44	Stick
AT80C32X2-RLTUV	ROMLess	5V ±10%	Industrial & Green	60 MHz <sup>(3)</sup>	VQFP44	Tray
TS80C52X2zzz-MCA	8K ROM	2.7 to 5.5V	Commercial	40 MHz <sup>(1)</sup>	PDIL40	Stick
TS80C52X2zzz-MCB	8K ROM	2.7 to 5.5V	Commercial	40 MHz <sup>(1)</sup>	PLCC44	Stick
TS80C52X2zzz-MCC	8K ROM	2.7 to 5.5V	Commercial	40 MHz <sup>(1)</sup>	PQFP44	Tray
TS80C52X2zzz-MCE	8K ROM	2.7 to 5.5V	Commercial	40 MHz <sup>(1)</sup>	VQFP44	Tray
TS80C52X2zzz-LCA	8K ROM	2.7 to 5.5V	Commercial	30 MHz <sup>(1)</sup>	PDIL40	Stick
TS80C52X2zzz-LCB	8K ROM	2.7 to 5.5V	Commercial	30 MHz <sup>(1)</sup>	PLCC44	Stick
TS80C52X2zzz-LCC	8K ROM	2.7 to 5.5V	Commercial	30 MHz <sup>(1)</sup>	PQFP44	Tray
TS80C52X2zzz-LCE	8K ROM	2.7 to 5.5V	Commercial	30 MHz <sup>(1)</sup>	VQFP44	Tray
TS80C52X2zzz-VCA	8K ROM	5V <u>±</u> 10%	Commercial	60 MHz <sup>(3)</sup>	PDIL40	Stick
TS80C52X2zzz-VCB	8K ROM	5V ±10%	Commercial	60 MHz <sup>(3)</sup>	PLCC44	Stick
TS80C52X2zzz-VCC	8K ROM	5V ±10%	Commercial	60 MHz <sup>(3)</sup>	PQFP44	Tray
TS80C52X2zzz-VCE	8K ROM	5V ±10%	Commercial	60 MHz <sup>(3)</sup>	VQFP44	Tray
TS80C52X2zzz-MIA	8K ROM	5V ±10%	Industrial	40 MHz <sup>(1)</sup>	PDIL40	Stick
TS80C52X2zzz-MIB	8K ROM	5V ±10%	Industrial	40 MHz <sup>(1)</sup>	PLCC44	Stick
TS80C52X2zzz-MIC	8K ROM	5V ±10%	Industrial	40 MHz <sup>(1)</sup>	PQFP44	Tray
TS80C52X2zzz-MIE	8K ROM	5V ±10%	Industrial	40 MHz <sup>(1)</sup>	VQFP44	Tray
TS80C52X2zzz-LIA	8K ROM	2.7 to 5.5V	Industrial	30 MHz <sup>(1)</sup>	PDIL40	Stick
TS80C52X2zzz-LIB	8K ROM	2.7 to 5.5V	Industrial	30 MHz <sup>(1)</sup>	PLCC44	Stick
TS80C52X2zzz-LIC	8K ROM	2.7 to 5.5V	Industrial	30 MHz <sup>(1)</sup>	PQFP44	Tray
TS80C52X2zzz-LIE	8K ROM	2.7 to 5.5V	Industrial	30 MHz <sup>(1)</sup>	VQFP44	Tray
TS80C52X2zzz-VIA	8K ROM	5V ±10%	Industrial	60 MHz <sup>(3)</sup>	PDIL40	Stick
TS80C52X2zzz-VIB	8K ROM	5V ±10%	Industrial	60 MHz <sup>(3)</sup>	PLCC44	Stick
TS80C52X2zzz-VIC	8K ROM	5V ±10%	Industrial	60 MHz <sup>(3)</sup>	PQFP44	Tray
TS80C52X2zzz-VIE	8K ROM	5V ±10%	Industrial	60 MHz <sup>(3)</sup>	VQFP44	Tray
AT80C52X2zzz-3CSUM	8K ROM	5V ±10%	Industrial & Green	40 MHz <sup>(1)</sup>	PDIL40	Stick
AT80C52X2zzz-SLSUM	8K ROM	5V ±10%	Industrial & Green	40 MHz <sup>(1)</sup>	PLCC44	Stick
AT80C52X2zzz-RLTUM	8K ROM	5V ±10%	Industrial & Green	40 MHz <sup>(1)</sup>	VQFP44	Tray

# Table 37. Possible Ordering Entries (Continued)

	. 0	. \ /				
Part Number <sup>(3)</sup>	Memory Size	Supply Voltage	Temperature Range	Max Frequency	Package	Packing
AT80C52X2zzz-3CSUL	8K ROM	2.7 to 5.5V	Industrial & Green	30 MHz <sup>(1)</sup>	PDIL40	Stick
AT80C52X2zzz-SLSUL	8K ROM	2.7 to 5.5V	Industrial & Green	30 MHz <sup>(1)</sup>	PLCC44	Stick
AT80C52X2zzz-RLTUL	8K ROM	2.7 to 5.5V	Industrial & Green	30 MHz <sup>(1)</sup>	VQFP44	Tray
AT80C52X2zzz-3CSUV	8K ROM	5V ±10%	Industrial & Green	60 MHz <sup>(3)</sup>	PDIL40	Stick
AT80C52X2zzz-SLSUV	8K ROM	5V ±10%	Industrial & Green	60 MHz <sup>(3)</sup>	PLCC44	Stick
AT80C52X2zzz-RLTUV	8K ROM	5V ±10%	Industrial & Green	60 MHz <sup>(3)</sup>	VQFP44	Tray
TS87C52X2-MCA	8K OTP	5V ±10%	Commercial	40 MHz <sup>(1)</sup>	PDIL40	Stick
TS87C52X2-MCB	8K OTP	5V ±10%	Commercial	40 MHz <sup>(1)</sup>	PLCC44	Stick
TS87C52X2-MCC	8K OTP	5V ±10%	Commercial	40 MHz <sup>(1)</sup>	PQFP44	Tray
TS87C52X2-MCE	8K OTP	5V ±10%	Commercial	40 MHz <sup>(1)</sup>	VQFP44	Tray
TS87C52X2-LCA	8K OTP	2.7 to 5.5V	Commercial	30 MHz <sup>(1)</sup>	PDIL40	Stick
TS87C52X2-LCB	8K OTP	2.7 to 5.5V	Commercial	30 MHz <sup>(1)</sup>	PLC44	Stick
TS87C52X2-LCC	8K OTP	2.7 to 5.5V	Commercial	30 MHz <sup>(1)</sup>	PQFP44	Tray
TS87C52X2-LCE	8K OTP	2.7 to 5.5V	Commercial	30 MHz <sup>(1)</sup>	VQFP44	Tray
TS87C52X2-VCA	8K OTP	5V ±10%	Commercial	60 MHz <sup>(3)</sup>	PDIL40	Stick
TS87C52X2-VCB	8K OTP	5V ±10%	Commercial	60 MHz <sup>(3)</sup>	PLCC44	Stick
TS87C52X2-VCC	8K OTP	5V ±10%	Commercial	60 MHz <sup>(3)</sup>	PQFP44	Tray
TS87C52X2-VCE	8K OTP	5V ±10%	Commercial	60 MHz <sup>(3)</sup>	VQFP44	Tray
TS87C52X2-MIA	8K OTP	5V ±10%	Industrial	40 MHz <sup>(1)</sup>	PDIL40	Stick
TS87C52X2-MIB	8K OTP	5V ±10%	Industrial	40 MHz <sup>(1)</sup>	PLCC44	Stick
TS87C52X2-MIC	8K OTP	5V ±10%	Industrial	40 MHz <sup>(1)</sup>	PQFP44	Tray
TS87C52X2-MIE	8K OTP	5V ±10%	Industrial	40 MHz <sup>(1)</sup>	VQFP44	Tray
TS87C52X2-LIA	8K OTP	2.7 to 5.5V	Industrial	30 MHz <sup>(1)</sup>	PDIL40	Stick
TS87C52X2-LIB	8K OTP	2.7 to 5.5V	Industrial	30 MHz <sup>(1)</sup>	PLCC44	Stick
TS87C52X2-LIC	8K OTP	2.7 to 5.5V	Industrial	30 MHz <sup>(1)</sup>	PQFP44	Tray
TS87C52X2-LIE	8K OTP	2.7 to 5.5V	Industrial	30 MHz <sup>(1)</sup>	VQFP44	Tray
TS87C52X2-VIA	8K OTP	5V ±10%	Industrial	60 MHz <sup>(3)</sup>	PDIL40	Stick
TS87C52X2-VIB	8K OTP	5V ±10%	Industrial	60 MHz <sup>(3)</sup>	PLCC44	Stick
TS87C52X2-VIC	8K OTP	5V ±10%	Industrial	60 MHz <sup>(3)</sup>	PQFP44	Tray
TS87C52X2-VIE	8K OTP	5V ±10%	Industrial	60 MHz <sup>(3)</sup>	VQFP44	Тгау

![](_page_19_Picture_3.jpeg)

![](_page_20_Picture_0.jpeg)

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